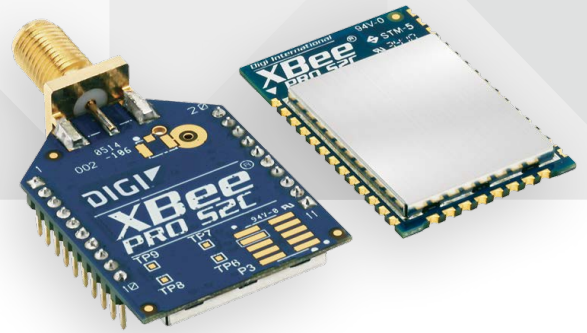




MESH NETWORKING
EMBEDDED RF
MODULES FOR OEMS



DIGI XBEE® S2C DIGIMESH® 2.4

Embedded RF modules deliver wireless connectivity using the innovative and easy-to-deploy DigiMesh protocol

Digi XBee DigiMesh S2C 2.4 embedded RF modules provide wireless connectivity to electronic devices using a globally deployable 2.4 GHz transceiver. These modules use the DigiMesh networking protocol. This innovative, peer-to-peer mesh network offers users added network stability through self-healing, dense network operation, extending the operational life of battery dependent networks.

Digi XBee modules are ideal for low-power applications. Digi XBee-PRO modules are power-amplified versions of Digi XBee modules for extended-range applications. Products in the Digi XBee family are easy to use, share a common hardware footprint, and are fully interoperable with other

Digi XBee products utilizing the same technology. They are available in a variety of different protocols to suit different applications, enabling users to substitute one Digi XBee module for another with minimal development time and risk.

The updated Digi XBee S2C DigiMesh module is built with the SiliconLabs EM357 SoC and offers improved power consumption, support for over-the-air firmware updates, and provides an upgrade path to IEEE 802.15.4 or ZigBee® mesh protocols if desired.

BENEFITS

- No configuration needed for out-of-the-box RF communications
- Common XBee footprint for a variety of RF modules
- Simple topology to deploy and grow
- 2.4 GHz for worldwide deployment
- Low-power XBee or extended-range XBee-PRO (pin/over-the-air compatible)
- Multiple antenna options
- Outdoor RF line-of-sight range up to 2 miles (3.2 km) with high-gain antennas
- DigiMesh peer-to-peer mesh networking protocol
 - Supports self-healing and discovery for network stability

RELATED PRODUCTS



Gateways



Modules



Adapters

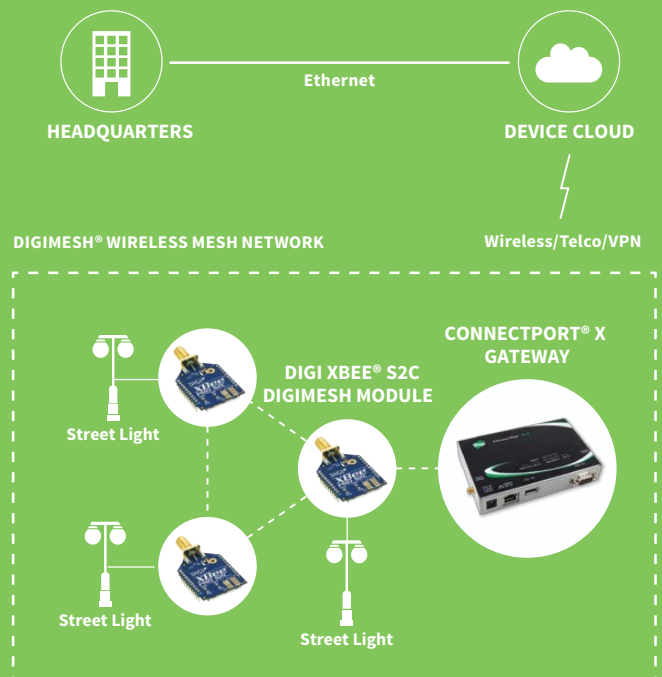


Network
Extenders



Development
Kits

APPLICATION EXAMPLE



SPECIFICATIONS

Digi XBee® S2C DigiMesh® 2.4

DigiXBee-PRO® S2C DigiMesh® 2.4

PERFORMANCE

TRANSCEIVER CHIPSET	Silicon Labs EM357 SoC	Silicon Labs EM357 SoC
DATA RATE	RF 250 Kbps, Serial up to 1 Mbps	RF 250 Kbps, Serial up to 1 Mbps
INDOOR/URBAN RANGE	200 ft (60 m)	300 ft (90 m)
OUTDOOR/RF LINE-OF-SIGHT RANGE	4000 ft (1200 m)	2 miles (3200 m)
TRANSMIT POWER	3.1 mW (+5 dBm) / 6.3 mW (+8 dBm) boost mode	63 mW (+18 dBm)
RECEIVER SENSITIVITY (1% PER)	-100 dBm / -102 dBm boost mode	-101 dBm

FEATURES

SERIAL DATA INTERFACE	UART, SPI	UART, SPI
CONFIGURATION METHOD	API or AT commands, local or over-the-air (OTA)	API or AT commands, local or over-the-air (OTA)
FREQUENCY BAND	ISM 2.4 GHz	ISM 2.4 GHz
FORM FACTOR	Through-Hole, Surface Mount	Through-Hole, Surface Mount
HARDWARE	S2C	S2C
ADC INPUTS	(4) 10-bit ADC inputs	(4) 10-bit ADC inputs
DIGITAL I/O	15	15
ANTENNA OPTIONS	Through-Hole: PCB Antenna, U.FL Connector, RPSMA Connector, or Integrated Wire; SMT: RF Pad, PCB Antenna, or U.FL Connector	
OPERATING TEMPERATURE	-40° C to +85° C	-40° C to +85° C
DIMENSIONS (L X W X H) AND WEIGHT	Through-Hole: 0.960 x 1.087 in (2.438 x 2.761 cm) SMT: 0.866 x 1.33 x 0.120 in (2.199 x 3.4 x 0.305 cm)	Through-Hole: 0.960 x 1.297 in (2.438 x 3.294 cm) SMT: 0.866 x 1.33 x 0.120 in (2.199 x 3.4 x 0.305 cm)

NETWORKING AND SECURITY

PROTOCOL	XBee DigiMesh 2.4 (Proprietary 802.15.4 based mesh protocol)	XBee DigiMesh 2.4 (Proprietary 802.15.4 based mesh protocol)
UPDATABLE TO DIGI 802.15.4 PROTOCOL	Yes	Yes
UPDATABLE TO ZIGBEE PROTOCOL	Yes	Yes
INTERFERENCE IMMUNITY	DSSS (Direct Sequence Spread Spectrum)	DSSS (Direct Sequence Spread Spectrum)
ENCRYPTION	128-bit AES	128-bit AES
RELIABLE PACKET DELIVERY	Retries/Acknowledgements	Retries/Acknowledgements
IDS	PAN ID and addresses, cluster IDs and endpoints (optional)	PAN ID and addresses, cluster IDs and endpoints (optional)
CHANNELS	16 channels	15 channels

POWER REQUIREMENTS

SUPPLY VOLTAGE	2.1 to 3.6V	2.7 to 3.6V
TRANSMIT CURRENT	33 mA @ 3.3 VDC / 45 mA boost mode	120 mA @ 3.3 VDC
RECEIVE CURRENT	28 mA @ 3.3 VDC / 31 mA boost mode	31 mA @ 3.3 VDC
POWER-DOWN CURRENT	<1 µA @ 25° C	<1 µA @ 25° C

REGULATORY APPROVALS

FCC, IC (NORTH AMERICA)	Yes	Yes
ETSI (EUROPE)	Yes	No
RCM (AUSTRALIA AND NEW ZEALAND)	Yes	Yes
TELEC (JAPAN)	Yes	No (Coming soon)

PART NUMBERS	DESCRIPTION
SMT MODELS	
XB24CDMPIS-001	Digi XBee, S2C DigiMesh 2.4, SMT, PCB antenna
XBP24CDMPIS-001	Digi XBee-PRO, S2C DigiMesh 2.4, SMT PCB antenna
XB24CDMUIS-001	Digi XBee, S2C DigiMesh 2.4, SMT, U.FL
XBP24CDMUIS-001	Digi XBee-PRO, S2C DigiMesh 2.4, SMT, U.FL
XB24CDMRIS-001	Digi XBee, S2C DigiMesh 2.4, SMT, RF Pad
XBP24CDMRIS-001	Digi XBee-PRO, S2C DigiMesh 2.4, SMT, RF Pad
THROUGH-HOLE MODELS	
XB24CDMPIT-001	Digi XBee, S2C DigiMesh 2.4, TH, PCB antenna
XBP24CDMPIT-001	Digi XBee-PRO, S2C DigiMesh 2.4, TH, PCB antenna
XB24CDMUIT-001	Digi XBee, S2C DigiMesh 2.4, TH, U.FL
XBP24CDMUIT-001	Digi XBee-PRO, S2C DigiMesh 2.4, TH, U.FL
XB24CDMSIT-001	Digi XBee, S2C DigiMesh 2.4, TH, RPSMA
XBP24CDMSIT-001	Digi XBee-PRO, S2C DigiMesh 2.4, TH, RPSMA
XB24CDMWIT-001	Digi XBee, S2C DigiMesh 2.4, TH, WIRE antenna
XBP24CDMWIT-001	Digi XBee-PRO, S2C DigiMesh 2.4, TH, WIRE antenna
KIT	
XK-WDM	Digi XBee S2C DigiMesh Development Kit with two XB24CDMPIT-001 modules and one XB24DMPIS-001 module

Note: International users select the standard module. The PRO module is for use in North America only.

